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DATA SHEET

AS196-307, AS196-307LF: GaAs IC High-Isolation SPDT Nonreflective Switch with Driver LF-6 GHz

Features

- Positive voltage control (0/3 to 0/5 V)
- High isolation (55 dB @ 0.9 GHz and 1.9 GHz)
- LPCC 4 x 4 mm package
- Integrated silicon CMOS driver
- Nonreflective
- Available lead (Pb)-free and RoHS-compliant MSL-1 @ 260 °C per JEDEC J-STD-020

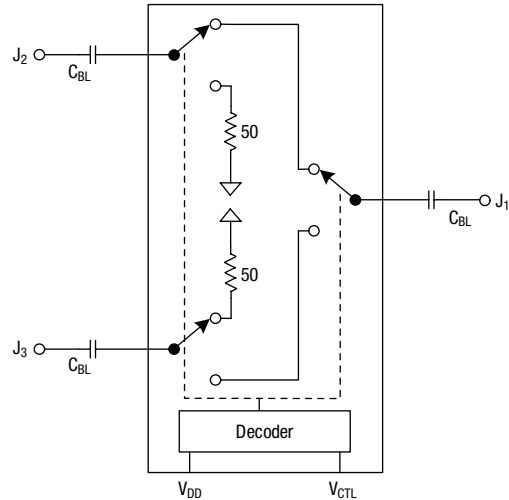
Description

The AS196-307 is a GaAs FET IC SPDT nonreflective switch packaged in a 16-lead exposed pad plastic package for low-cost, high-isolation commercial applications. Ideal building block for base station applications where synthesizer isolation is critical. Typical applications include GSM, PCS, WCDMA, 2.4 and 5.8 GHz ISM and wireless local loop.

NEW Skyworks offers lead (Pb)-free, RoHS (Restriction of Hazardous Substances)-compliant packaging.



Functional Block Diagram



$C_{BL} = 47 \text{ pF}$ for operation > 500 MHz.

Electrical Specifications (0, 5 V) -40 °C to +85 °C

Parameter ⁽¹⁾	Frequency	Min.	Typ.	Max.	Unit
Insertion loss	LF-2 GHz		0.9	1.15	dB
	LF-3 GHz		1.0	1.25	dB
	LF-4 GHz		1.2	1.40	dB
	LF-6 GHz		1.6	2.00	dB
Isolation ⁽²⁾	LF-2 GHz	50	55		dB
	LF-3 GHz	43	50		dB
	LF-4 GHz	35	40		dB
	LF-6 GHz	25	30		dB
VSWR (on state)	LF-2 GHz		1.3:1	1.5:1	
	LF-6 GHz		1.3:1	1.6:1	
VSWR (off state)	0.5-6 GHz		1.35:1	1.7:1	

1. All measurements made in a 50 Ω system, unless otherwise specified.
 2. Backside of exposed pad must be connected to RF ground to obtain specified isolation.

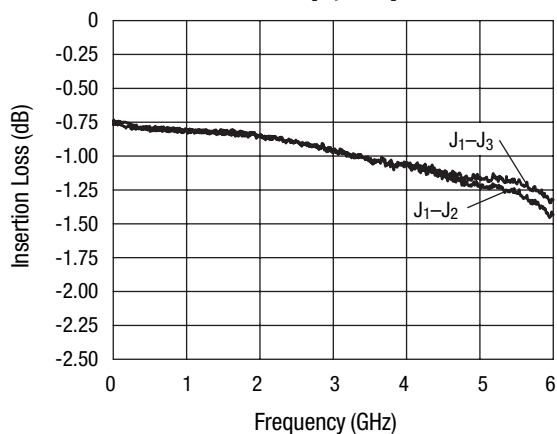
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Operating Characteristics (0, 5 V) -40 °C to +85 °C

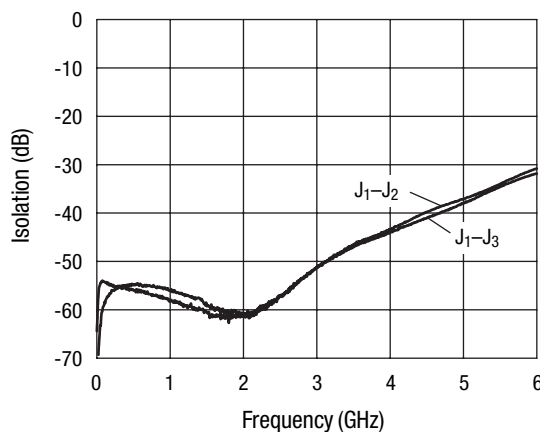
Parameter	Condition	Frequency	Min.	Typ.	Max.	Unit
Switching characteristics ⁽¹⁾						
Rise, fall	10/90% or 90/10% RF			30		ns
On, off	50% CTL to 90/10% Rf			50		ns
Video feedthru	T _{RISE} = 3 ns, BW = 500 MHz			25		mV
Input power for 1 dB compression	V _{CTL} = 0/3 V	0.9–6 GHz	17	21		dBm
	V _{CTL} = 0/5 V	0.9–6 GHz	24	27		dBm
Intermodulation intercept point (IP3)	For two-tone input power +8 dBm					
	V _{CTL} = 0/3 V	0.9–6 GHz	30	38		dBm
	V _{CTL} = 0/5 V	0.9–6 GHz	38	46		dBm
Thermal resistance				25		°C/W
Control voltage	Low ("0")		0		0.5	V
	High ("1")		V _{DD} -0.6		V _{DD}	V
Control current	V _{CTL} = "0" or "1". V _{DD} = 2.6 to 5 V			5		µA
Supply voltage	V _{DD}		2.6	3	5	V
Supply current	V _{DD} = 3 V			10	50	µA
	V _{DD} = 5 V			20	100	µA

1. V_{DD} must be powered on by a minimum of 10 ns prior to V_{CTL}.

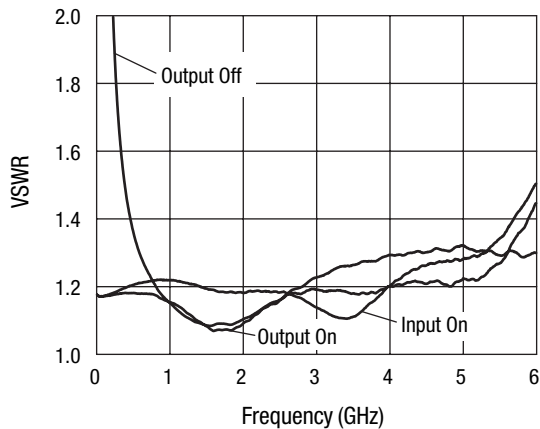
Typical Performance Data (0, 5 V)



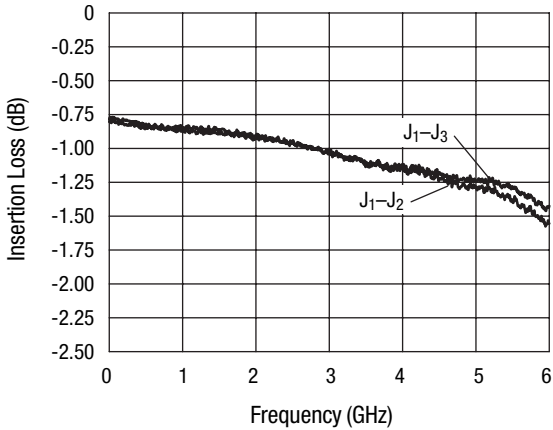
Insertion Loss, 25 °C
V_{DD} = 5 V, V_{CTL} = 0/5 V



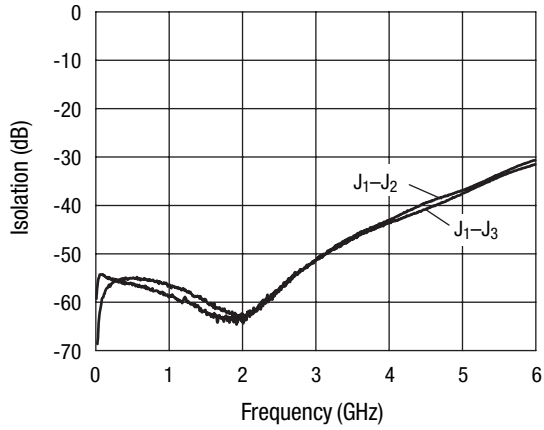
Isolation, 25 °C
V_{DD} = 5 V, V_{CTL} = 0/5 V



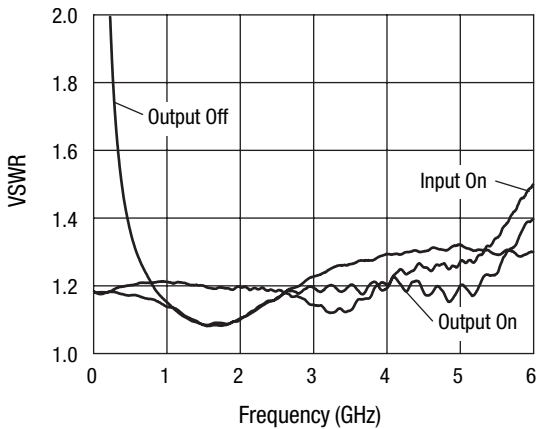
VSWR, 25 °C
V_{DD} = 5 V, V_{CTL} = 0/5 V



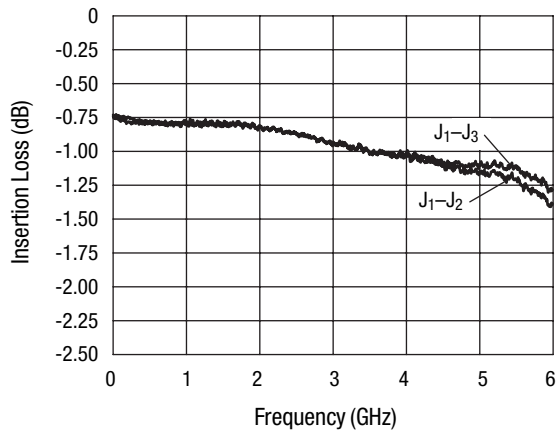
Insertion Loss, 85 °C
 $V_{DD} = 5\text{ V}, V_{CTL} = 0/5\text{ V}$



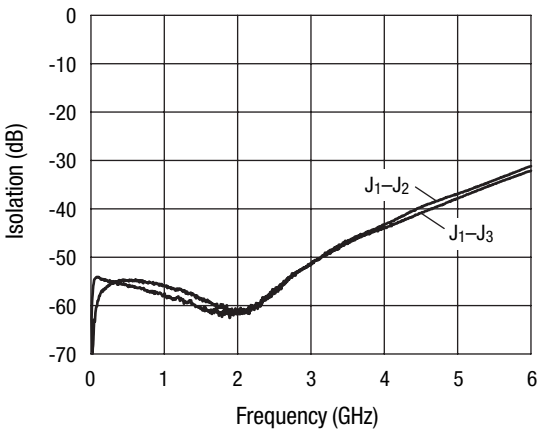
Isolation, 85 °C
 $V_{DD} = 5\text{ V}, V_{CTL} = 0/5\text{ V}$



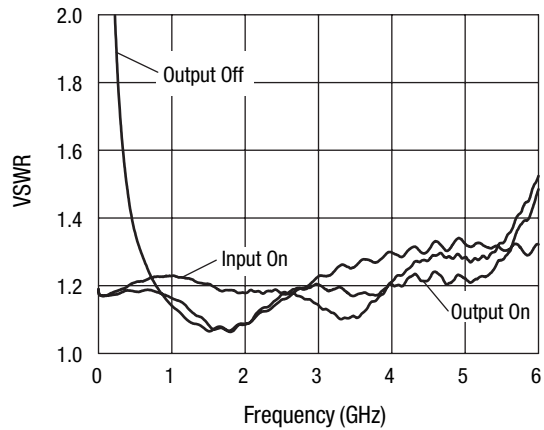
VSWR, 85 °C
 $V_{DD} = 5\text{ V}, V_{CTL} = 0/5\text{ V}$



Insertion Loss, -40 °C
 $V_{DD} = 5\text{ V}, V = 0/5\text{ V}$



Isolation, -40 °C
 $V_{DD} = 5\text{ V}, V_{CTL} = 0/5\text{ V}$



VSWR, -40 °C
 $V_{DD} = 5\text{ V}, V_{CTL} = 0/5\text{ V}$

Compression Point vs. Voltage and Temperature

Control Voltage (V)	Temperature (°C)	Input Power @ 1 dB Compression (dBm)	Input Power @ 0.1 dB Compression (dBm)
3	-40	20.5	16.5
3	25	20	15.3
3	85	19	14
5	-40	28.5	23
5	25	28	23
5	85	27.5	23

Frequency: 500 MHz.

Absolute Maximum Ratings

Characteristic	Value
RF input power	1 W max. > 500 MHz, 0/8 V control
Control voltage	-0.2 V, +8 V
Operating temperature	-40 °C to +85 °C
Storage temperature	-65 °C to +150 °C

Performance is guaranteed only under the conditions listed in the specifications table and is not guaranteed under the full range(s) described by the Absolute Maximum specifications. Exceeding any of the absolute maximum/minimum specifications may result in permanent damage to the device and will void the warranty.

CAUTION: Although this device is designed to be as robust as possible, ESD (Electrostatic Discharge) can damage this device. This device must be protected at all times from ESD. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection. Industry-standard ESD precautions must be employed at all times.

Recommended Solder Reflow Profiles

Refer to the [“Recommended Solder Reflow Profile”](#) Application Note.

Tape and Reel Information

Refer to the [“Discrete Devices and IC Switch/Attenuators Tape and Reel Package Orientation”](#) Application Note.

IP3 vs. Voltage and Temperature

Control Voltage (V)	Temperature (°C)	IP3 @ 5 dBm Each T one (dBm)
3	-40	45.5
3	25	45
3	85	34
5	-40	45.5
5	25	45.5
5	85	40.5

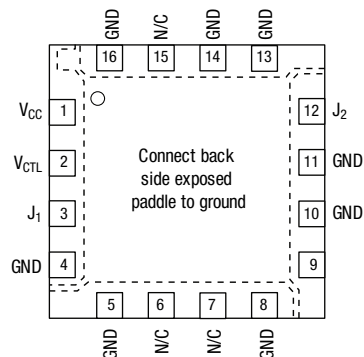
Two tone input power: 5 dBm each tone.
Tone frequencies: 900 and 901 MHz.

Truth Table

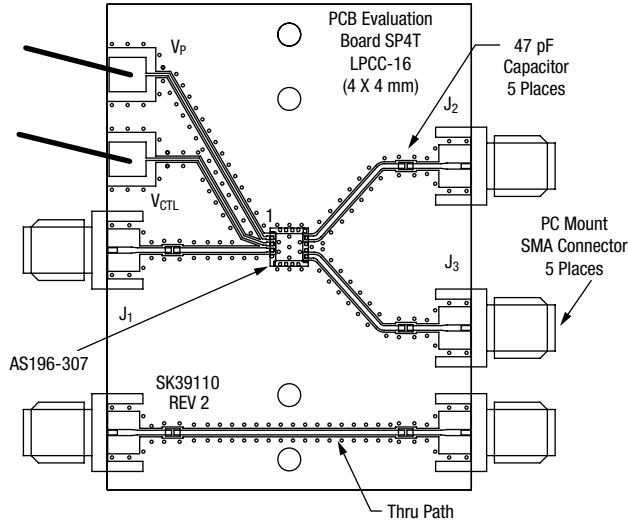
V _{CTL}	J ₁ -J ₂	J ₁ -J ₃
0	Insertion loss	Isolation
1	Isolation	Insertion loss

“0” = 0–0.5 V.
“1” = 3.5–5 V.
V_{DD} = 5 V.

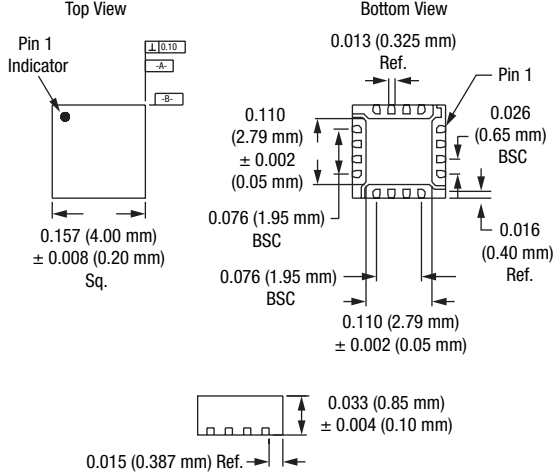
Pin Out (Top View)



Evaluation PCB



LPCC 4 x 4 (-307)



PCB# SK39110. Material: FR4.
 The circuit board used in the final application should employ RF circuit design techniques. RF signal lines should have 50 Ω impedance. The package bottom ground plane should be connected directly to PCB ground plane. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available upon request.

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